WR0516

Fast Transient Response, 500mA, CMOS LDO

1. General Description

The WR0516 series is a high accuracy, low noise, high speed, high PSRR, low dropout CMOS Linear regulator. The WR0516 is a linear regulator capable of supplying 500mA output current. The input voltage is as low as Min. 1.6V and the output voltage can be set from 0.7V.

Each of these ICs consists of a voltage reference unit, an error amplifier, a resistor-net for voltage setting, a current-limiting circuit, and a thermal-shutdown circuit.

The WR0516 regulators are available in Green SOT23-5 Package and DFN1×1-4 Package.

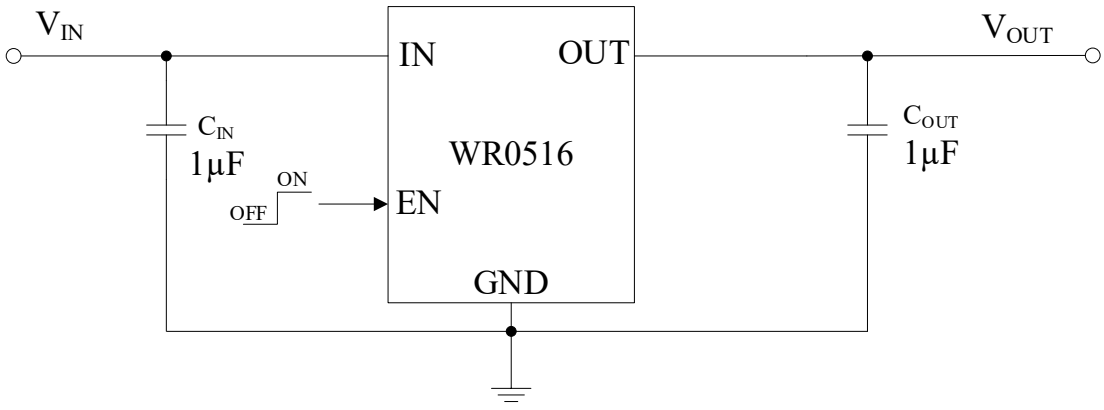
2. Features

- Input Voltage Range: 1.6V to 5.5V
- Output Voltage Range: 0.7V to 3.6V
- Output Current: 500mA
- Dropout Voltage: 130mV (Typ.) @ V_{OUT} = 3.3V, I_{OUT}=500mA
- Quiescent Current: 85μA(typ.)
- Shut-down Current: 0.1μA(typ.)
- Stable with Small 1μF Ceramic Capacitors
- High Output voltage Accuracy: ±0.8%
- Operating Temperature: -40 to +85℃
- Excellent Load/Line Transient Response

3. Applications

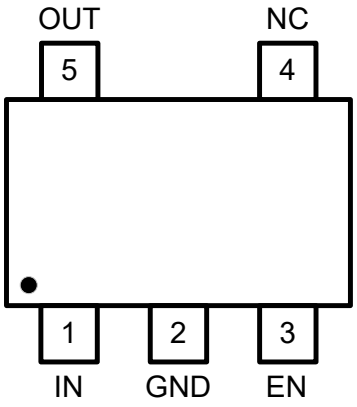
- Portable and Battery-Powered Equipment
- Portable Communication Equipment
- Cameras, Image Sensors and Camcorder

4. Typical Application

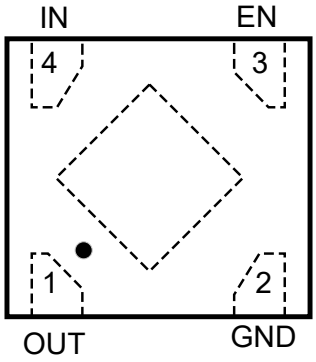


5. Pin Configuration

(Top View)



SOT23-5



DFN1×1-4

6. Pin Description

PIN NUMBER		PIN NAME	I/O	PIN FUNCTION
SOT23-5	DFN1×1-4			
1	4	IN	I	Input voltage supply. Bypass with a typical 1μF capacitor to GND. Place the input capacitor as close to the IN and GND pins of the device as possible.
2	2	GND	-	Common ground.
3	3	EN	I	Enable input. Active High. EN includes a small pull-down current source, nominally 0.1μ A.
4	-	NC	-	NC
5	1	OUT	O	Regulated output voltage. A low equivalent series resistance (ESR) capacitor, typically 1μF, is required from OUT to ground for stability. Place the output capacitor as close to the OUT and GND pins of the device as possible.
-	-	EPAD	-	Exposed pad. It should be connected directly to the GND pin as short as possible or leave floating. Connect the EPAD to a large-area ground plane for best thermal performance. Do not connect to any potential other than GND.

7. Absolute Maximum Ratings

Operating free-air temperature range (unless otherwise noted)[1]

SYMBOL	PARAMETER		RATING	UNIT
V_{IN}	Input voltage range		-0.3 to 6.0	V
V_{EN}	EN Input voltage range		-0.3 to V_{IN}	
V_{OUT}	Output voltage range		-0.3 to 6.0	
P_D	Power Dissipation $P_{D(MAX)}$@T_A = 25ºC	SOT23-5	600	mW
		DFN1×1-4	560	
$R_{\theta JA}$	Thermal resistance[2] [4]	SOT23-5	208	℃/W
		DFN1×1-4	223	
$R_{\theta JB}$	Thermal Resistance[2] [3]	SOT23-5	189.09	℃/W
		DFN1×1-4	204.8	
$R_{\theta JC}$	Top Thermal Resistance[2] [3]	SOT23-5	98.9	℃/W
		DFN1×1-4	131.6	
$R_{\theta JC}$	Bottom Thermal Resistance[2] [3]	SOT23-5	46.36	℃/W
		DFN1×1-4	56.54	
T_J	Junction Temperature		150	℃
T_{SDR}	Lead Temperature Range		260	
T_{STG}	Storage Temperature Range		-55 to 150	
ESD	ESD susceptibility	HBM	±4000	V

NOTE1: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE2: Measured on 2cm x 2cm 2-layer FR4 PCB board, 2 oz copper, no via holes on GND copper.

NOTE3: Measured according to JEDEC board specification. Detailed description of the board can be found in JESD51−7.

NOTE4: Power dissipation is calculate by $P_{D(MAX)} = (T_J - T_A) / R_{\theta JA}$.

8. Recommended Operating Conditions

SYMBOL	PARAMETER	RATING	UNIT
V_{IN}	Input voltage range	1.6 to 5.5	V
V_{EN}	EN Input voltage range	0 to 5.5	
V_{OUT}	Nominal output voltage range	0.7 to 3.6	
I_{OUT}	Output current	0 to 500	mA
C_{IN}	Input capacitor	1	μF
C_{OUT}	Output capacitor	1	
T_A	Operating Ambient temperature	-40 to 85	℃

9. Electrical Characteristics

(V_{IN}=V_{OUT_NOM}+0.5V or V_{IN}=1.6V (Whichever is higher), V_{EN}=1.2V, I_{OUT}=1mA, C_{IN}=C_{OUT}=1.0μF, T_A=25℃, unless otherwise noted)

SYMBOL	PARAMETER	TEST CONDITIONS		MIN	TYP.	MAX	UNIT
V_{OUT}	Output Voltage	V_{OUT_NOM}≥1.8V	T_A=+25℃	-0.8		0.8	%
			-40℃≤T_A≤85℃	-2.0		1.0	
		V_{OUT_NOM}<1.8V	T_A=+25℃	-1.2		1.2	
			-40℃≤T_A≤85℃	-2.5		1.5	
V_{UVLO}	Under Voltage Lock-Out	V_{IN} Rising			1.3		V
V_{UVLO_HYS}	UVLO Hysteresis				0.1		V
LNR	Line Regulation	V_{IN} = V_{OUT_NOM} + 0.5V to 5.25V V_{IN} ≥ 1.6V, I_{OUT} = 1mA			0.02	0.1	%/V
LDR	Load Regulation [5]	1mA ≤ I_{OUT} ≤ 500mA, V_{IN} ≥ 1.8V			3	10	mV
V_{DO}	Dropout Voltage [6]	I_{OUT} = 500mA	1.2V ≤ V_{OUT} < 1.4V		520	580	mV
			1.4V ≤ V_{OUT} < 1.8V		295	380	
			1.8V ≤ V_{OUT} < 2.1V		200	285	
			2.1V ≤ V_{OUT} < 3.6V		150	260	
I_{OUT}	Output Current Limit [7]	V_{OUT} = V_{OUT_NOM} ×98%, V_{IN} ≥ 1.8V		500	1000		mA
		V_{OUT} = V_{OUT_NOM} ×98%, V_{IN}≥ 1.6V		300	600		
I_{SHORT}	Short Circuit Current	V_{OUT} = 0V, V_{IN} ≥ 1.8V		500	1000		mA
I_Q	Quiescent Current	I_{OUT}=0mA			85	110	μA
I_{SHDN}	Shut-down Current	V_{EN}=0V			0.1	3	μA
V_{ENH}	EN high voltage (enabled)	V_{IN}=5.5V		0.9			V
V_{ENL}	EN low voltage (disabled)	V_{IN}=5.5V				0.4	V

SYMBOL	PARAMETER	TEST CONDITIONS		MIN	TYP.	MAX	UNIT
I_{EN}	Enable Input Current	V_{EN} = V_{IN} = 5.5V			0.1	0.6	μA
PSRR	Power Supply Rejection Ratio	V_{IN} = (V_{OUT} + 1V) DC +0.2V_{P-P}, I_{OUT} = 10mA	f = 1kHz		75		dB
			f = 10kHz		60		
V_{NO}	Output Noise	f = 10 Hz to 100 kHz, I_{OUT} = 10mA	V_{OUT} = 0.7V		60		μV_{RMS}
			V_{OUT} = 1.8V		46		
			V_{OUT} = 3.3V		42		
R_{DIS}	Output Discharge Resistance	V_{IN} = 4.0V, V_{EN} = 0V, V_{OUT} = V_{OUT_NOM}			60		Ω
$\frac{\Delta V_{OUT}}{\Delta T_A \times V_{OUT}}$	Output Voltage Temperature Coefficient	I_{OUT}=1mA, T_A=-40 ~ 85℃			40		ppm/℃
T_{SD}	Thermal Shutdown Temperature				165		℃
ΔT_{SD}	Thermal Shutdown Hysteresis				25		

NOTE5: The Load regulation is measured by pulse test.

NOTE6: The dropout voltage is defined as (V_{IN}-V_{OUT}) when V_{OUT} is $V_{OUT(NOM)}$*98%.

NOTE7: Maximum output current is affected by the PCB layout, size of metal trace, the thermal conduction path between metal layers, ambient temperature and the other environment factors of system. Attention should be paid to the dropout voltage when V_{IN}< V_{OUT} + V_{DROP}

10. Typical Performance Characteristics

(V_{IN} =V_{OUT_NOM}+0.5V or V_{IN}=1.6V (Whichever is higher), V_{EN}=1.2V, I_{OUT}=1mA, C_{IN}=C_{OUT}=1.0μF, T_A=25℃, unless otherwise noted)

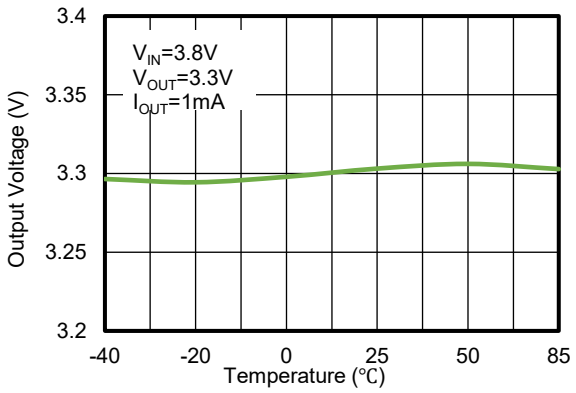


Figure 1. WR0516-33FF4R
Output Voltage vs. Ambient Temperature

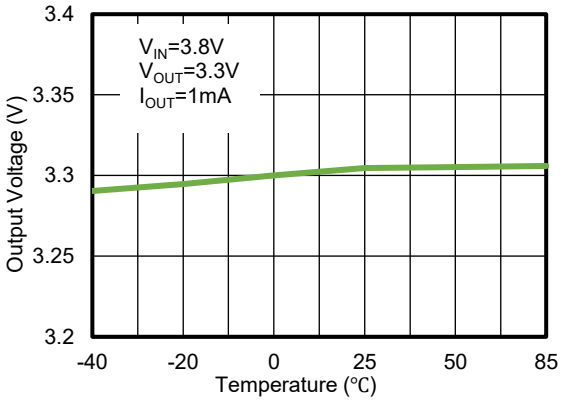


Figure 2. WR0516-33A50R
Output Voltage vs. Ambient Temperature

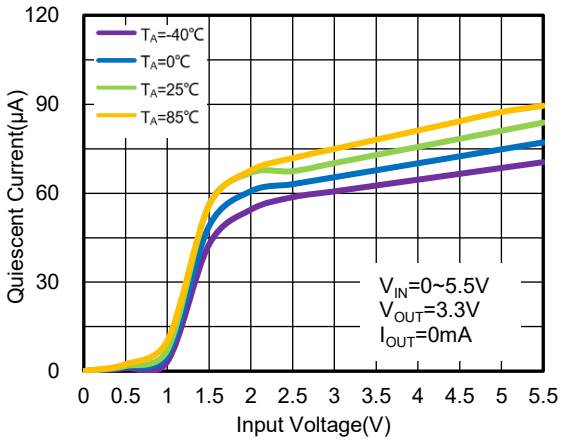


Figure 3. WR0516-33FF4R
Quiescent Current vs. V_{IN} & Ambient Temperature

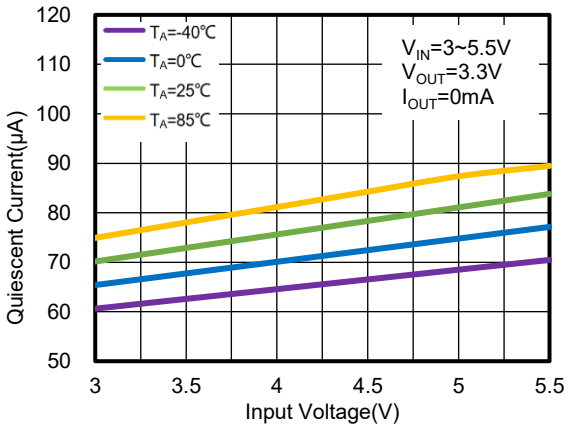


Figure 4. WR0516-33FF4R
Quiescent Current vs. V_{IN} & Ambient Temperature

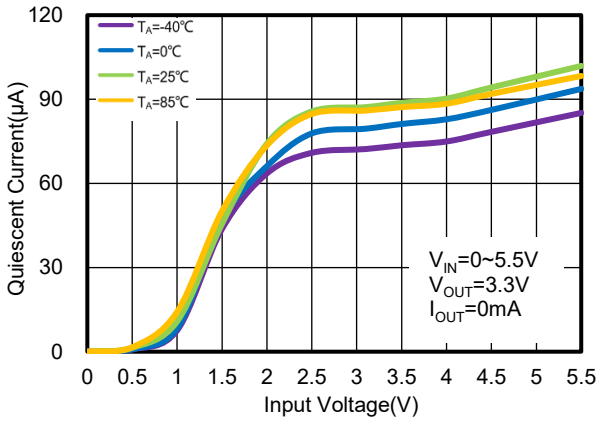


Figure 5. WR0516-33A50R
Quiescent Current vs. V_{IN} & Ambient Temperature

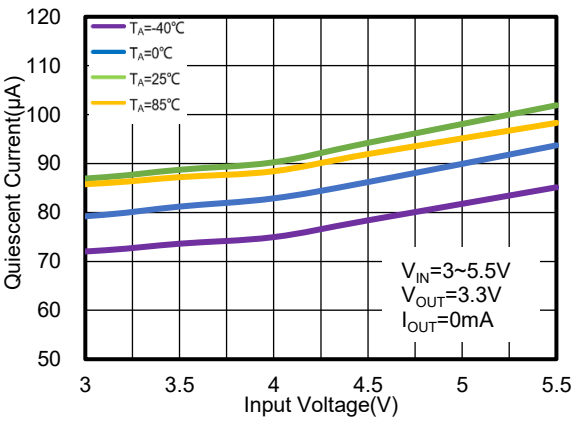


Figure 6. WR0516-33A50R
Quiescent Current vs. V_{IN} & Ambient Temperature

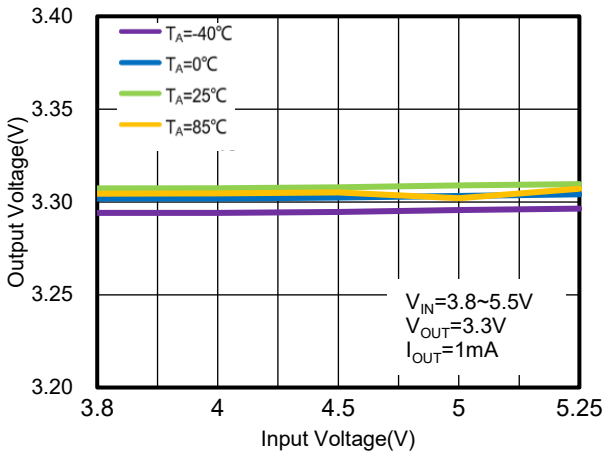


Figure 7. WR0516-33FF4R
Regulation vs. V_{IN} (Line Regulation) & Ambient Temperature

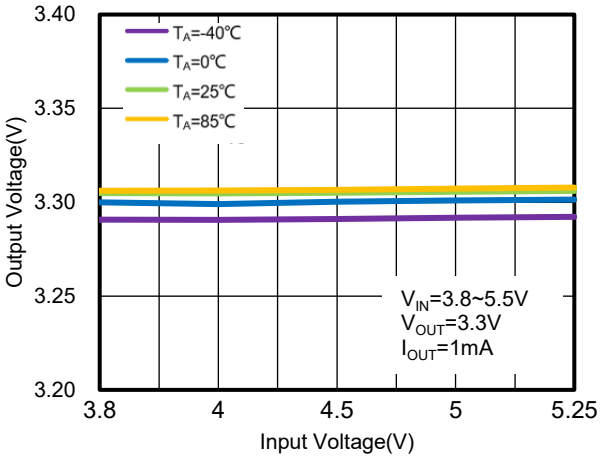


Figure 8. WR0516-33A50R
Regulation vs. V_{IN} (Line Regulation) & Ambient Temperature

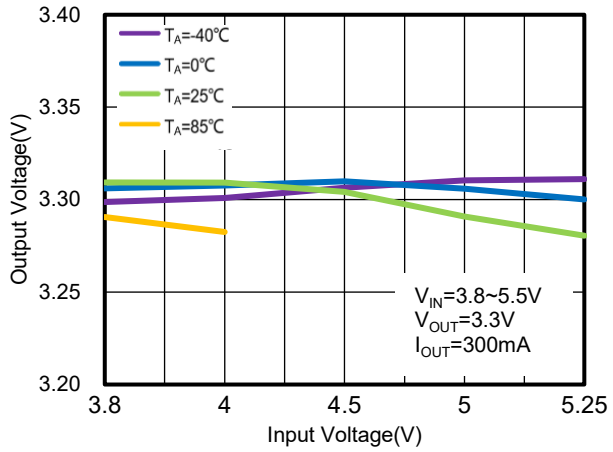


Figure 9. WR0516-33FF4R
Regulation vs. V_{IN} (Line Regulation) & Ambient Temperature

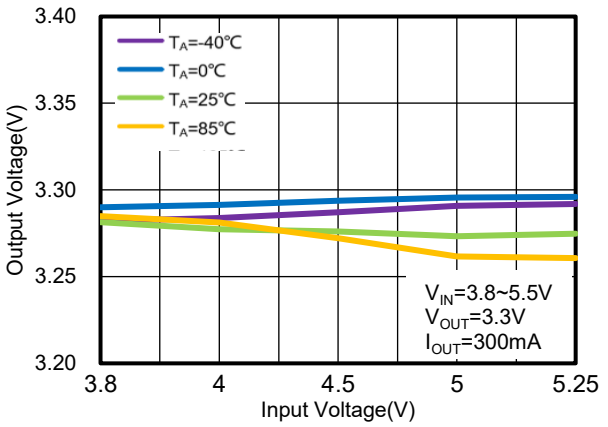


Figure 10. WR0516-33A50R
Regulation vs. V_{IN} (Line Regulation) & Ambient Temperature

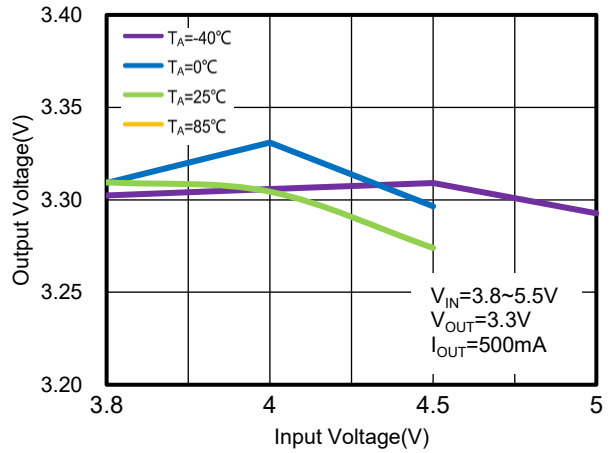


Figure 11. WR0516-33FF4R
Regulation vs. V_{IN} (Line Regulation) & Ambient Temperature

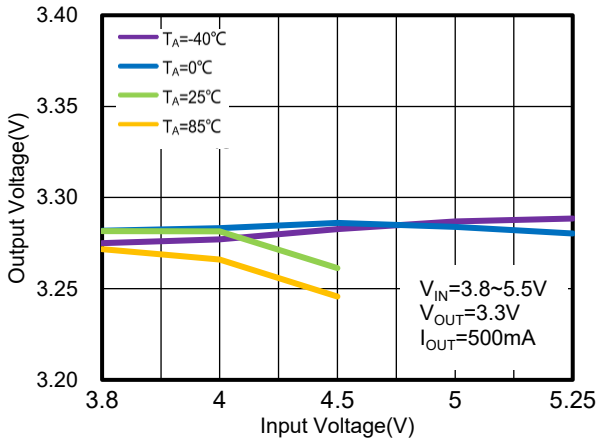


Figure 12. WR0516-33A50R
Regulation vs. V_{IN} (Line Regulation) & Ambient Temperature

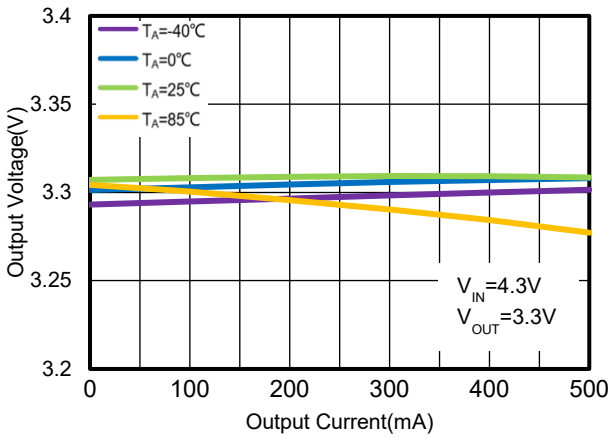


Figure 13. WR0516-33FF4R
Load Regulation vs. I_{OUT} & Ambient Temperature

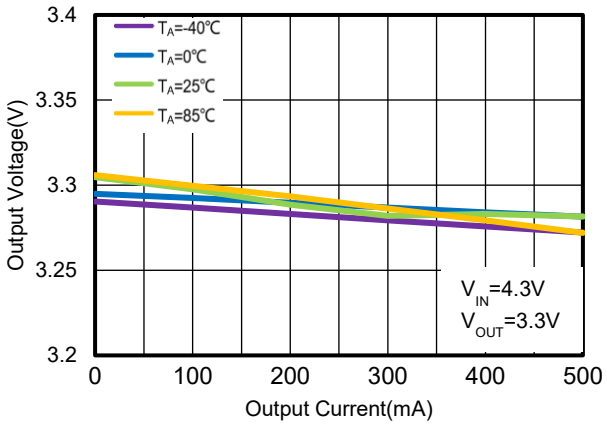


Figure 14. WR0516-33A50R
Load Regulation vs. I_{OUT} & Ambient Temperature

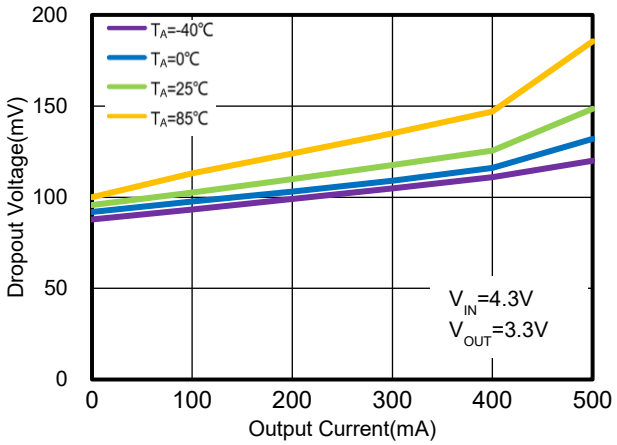


Figure 15. WR0516-33FF4R
Dropout Voltage vs. I_{OUT} & Ambient Temperature

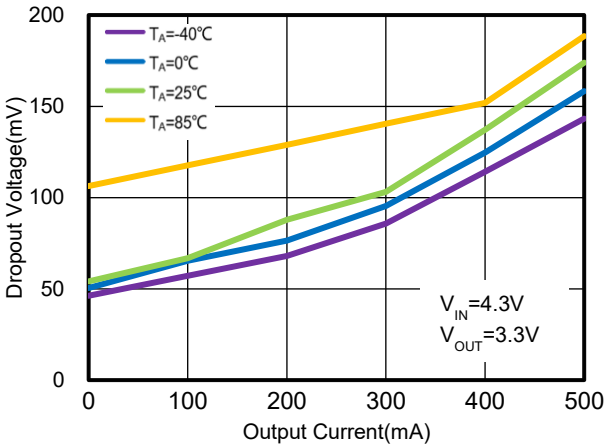


Figure 16. WR0516-33A50R
Dropout Voltage vs. I_{OUT} & Ambient Temperature

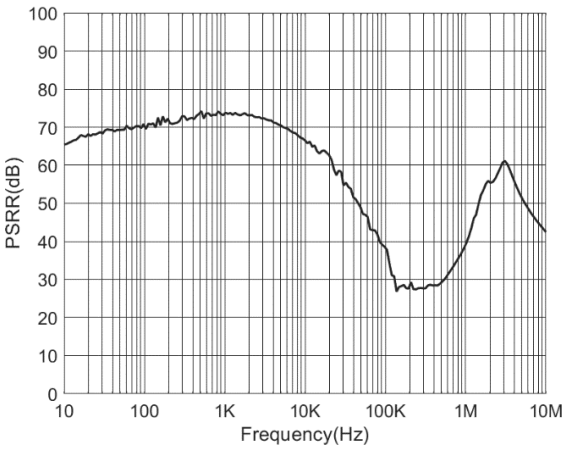


Figure 17. WR0516-12A50R PSRR

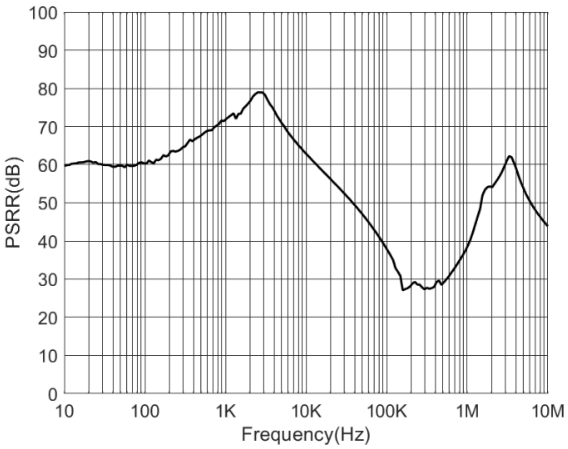


Figure 18. WR0516-33A50R PSRR

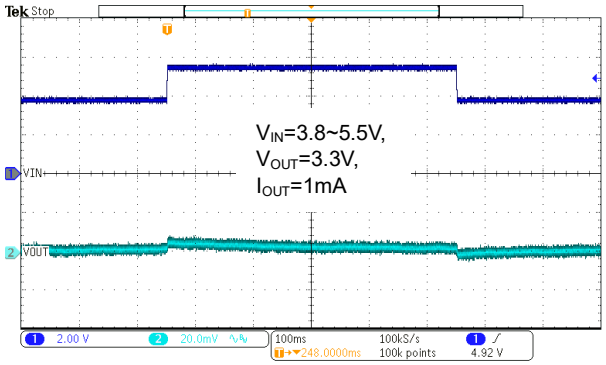


Figure 19. WR0516-33A50R Line Transient

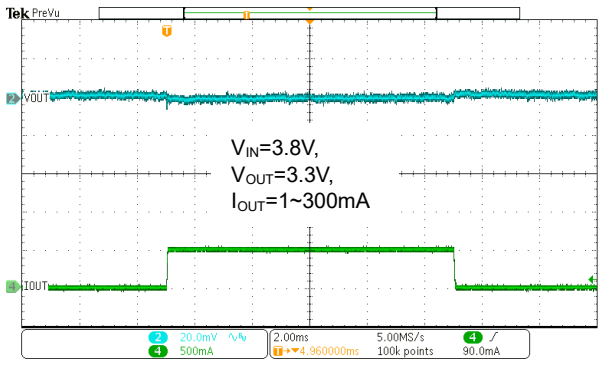


Figure 20. WR0516-33A50R Load Transient

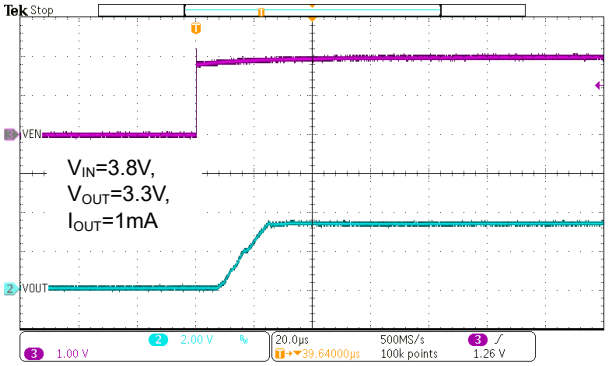


Figure 21. WR0516-33A50R Soft Start from EN

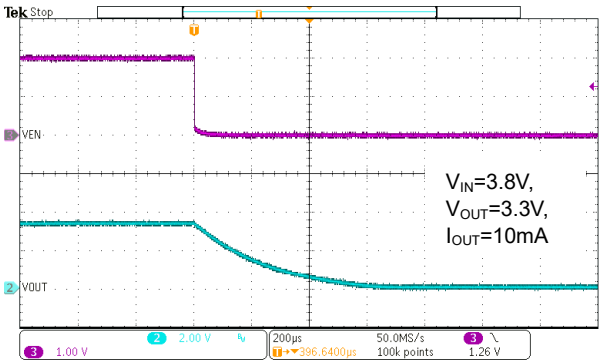


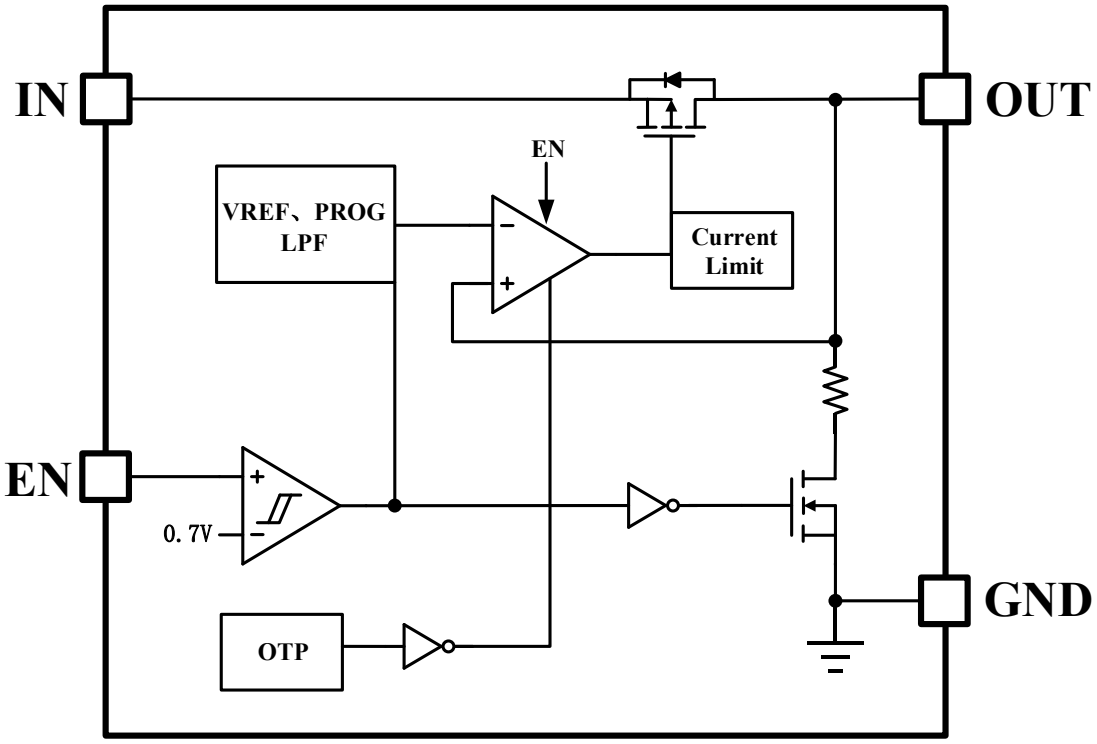
Figure 22. WR0516-33A50R EN Shutdown

11. Function Description

11.1 Overview

The WR0516 series is a high accuracy, low noise, high speed, high PSRR, low dropout CMOS Linear regulator. The WR0516 is a linear regulator capable of supplying 500mA output current. The input voltage is as low as Min. 1.6V and the output voltage can be set from 0.7V.

11.2 Block Diagram



11.3 Feature Description

11.3.1 Output Voltage Accuracy

Output voltage accuracy is defined as the maximum and minimum error in output voltage. This includes the errors introduced by internal reference, load regulation and line regulation differences over the full range of rated load and line operating conditions, taking into account differences between manufacturing lots. The output voltage accuracy of WR0516 is about 0.8% or 1.2% at T_A = 25℃ and maybe drift in full operating temperature.

11.3.2 Enable (EN)

The WR0516 EN pin has internal pull−down current source with value of 100nA typ. When the input voltage of the enable pin is higher than the high enable voltage threshold, the device output is normal. When the input voltage of the enable pin is lower than the low input voltage threshold of the EN pin, the device output is disabled. If you do not need to control the output voltage independently, connect the enable pin to the input of the device. When EN is disabled, the discharge transistor is activated and the output voltage V_{OUT} is pulled to GND through an internal circuitry with effective resistance about 60Ω.

When EN pin is floating, the device is disabled due to internal pull−down current source.

11.3.3 Dropout Voltage (V_{DO})

The WR0516 is an ultra-low dropout voltage LDO that can achieve nominal output voltage at lower input voltages. Dropout voltage is defined as the minimum of (V_{IN}-V_{OUT}) at the rated maximum output current where V_{OUT} is the minimum of $V_{OUT(NOM)}$. When the input voltage is below $V_{OUT(NOM)}$ plus V_{DO}, the output voltage varies with the input voltage.

For a CMOS regulator, the dropout voltage is determined by the drain-source on-state resistance ($R_{DS\ (ON)}$) of the pass transistor. Therefore, if the linear regulator operates at less than the rated current, the dropout voltage for that current scales accordingly. The $R_{DS\ (ON)}$ is calculated by following equation.

$$\mathbf{R_{DS\ (ON)}=V_{DO}/I_{OUT}}$$

11.3.4 Power Supply Rejection Ratio (PSRR)

PSRR, which stands for Power Supply Rejection Ratio, represents the ratio of the two voltage gains obtained when the input and output power supplies are considered as two independent sources.

The basic calculation formula is:

$$\mathbf{PSRR = 20lg\ (Ripple(in)\ /\ Ripple(out))}$$

The units are in decibels (dB) and the logarithmic ratio is used.

The above equation shows that the output signal is influenced by the power supply in general, in addition to the circuit itself. PSRR is a quantity used to describe how the output signal is affected by the power supply; the larger the PSRR, the less the output signal is affected by the power supply.

As the level of integration continues to increase, the magnitude of supply current required is also increasing. End users want to extend battery life, i.e., they need very efficient DC/DC conversion processes, using more efficient switching regulators. However, switching regulators generate more ripple in the power line than linear regulators.

The PSRR shows the ability of the LDO to suppress input voltage noise. For a clean, noise-free DC output voltage, use an LDO with a high PSRR.

Noise coupling from the input voltage to the internal reference voltage is the main cause of PSRR performance degradation. Using noise reduction capacitors at the input can effectively filter out noise and improve PSRR performance at low frequencies. The LDO can be used not only to regulate the voltage but also to provide an exceptionally clean DC supply for noise sensitive components.

The WR0516 is a high PSRR LDO that can be used not only for voltage regulation but also for noise cancellation in the power supply.

11.3.5 Noise

LDO noise can be divided into two main categories: internal noise and external noise. Internal noise is the noise generated inside the electronics; external noise is the noise transmitted from outside the circuit to the circuit. The error amplifier determines the PSRR of the LDO and therefore its ability to suppress external noise at the input; internal noise is always present at the output of the LDO.

In practice, minimizing noise from the power supply is critical to system performance. In test and measurement systems, small fluctuations in power supply noise can alter the instantaneous measurement accuracy.

The WR0516 has a low noise reference, high PSRR to ensure that output noise is reduced during normal operation.

11.3.6 Current Limit (I_{LIM})

In LDO circuits, if an output short circuit or excessive load current occurs, the device may be burned out. Especially in the case of a short circuit, not only is there too much current flowing through the regulator, but the voltage across the source drain of the regulator is also at its maximum, which is likely to burn out the regulator and make the device inoperable. The current limiting circuit used in LDO is a constant current limiting circuit, where the maximum load current that the LDO can supply is limited to a set constant I_{LIM}, and when an overload or short circuit occurs, the output current will be maintained at I_{LIM}, and the output voltage will be reduced to $I_{LIM}R_{LOAD}$.

The WR0516 uses a constant current limiting mode where the final current is around 1000 mA, thus providing good protection to the device.

11.3.7 Thermal Protection

The WR0516 contains a thermal shutdown protection circuit that implements the required switching gate circuit function through a thermal switch integrated inside the chip. The output current is turned off when the heat in the LDO is too high. Thermal shutdown occurs when the thermal junction temperature (T_J) of the energized crystal exceeds 165°C (typical). The thermal shutdown hysteresis ensures that the LDO resets (turns on) again when the temperature drops to 140°C (typical). The thermal time constant of the semiconductor chip is quite short, so when thermal shutdown is reached, the output turns on and off at a higher rate until the power dissipation is reduced.

The WR0516's internal protection circuitry is designed to prevent thermal overload conditions. This circuitry is not a substitute for a proper heat sink. Continuously putting the WR0516 into a thermal shutdown state will reduce the reliability of the device.

11.4 Functional Mode of the Device

The device has three modes: normal, dropout, and disabled modes of operation.

The operating conditions of each mode are listed in the table below.

Operating conditions of each mode

Functional Mode	Conditions			
	V_{IN}	V_{EN}	I_{OUT}	T_J
Normal	$5.5V \geq V_{IN} \geq V_{OUT(NOM)} + V_{DO}$	$V_{EN} > V_{ENH}$	$I_{OUT} < I_{LIM}$	$T_J < T_{SD}$
Dropout	$V_{UVLO} \leq V_{IN} < V_{OUT(NOM)} + V_{DO}$	$V_{EN} > V_{ENH}$	$I_{OUT} < I_{LIM}$	$T_J < T_{SD}$
Disabled	$V_{IN} < V_{UVLO}$	$V_{EN} < V_{ENL}$	-	$T_J > T_{SD}$

11.4.1 Normal Mode

Normal operating mode requires that both of the following conditions are met.

1. The input voltage is greater than the rated output voltage plus the differential voltage ($V_{OUT(NOM)} + V_{DO}$) and is less than 5.5V.
2. The enable voltage has previously exceeded the enable rise threshold voltage and has not fallen below the enable fall threshold.
3. The output current is less than the current limit ($I_{OUT} < I_{LIM}$).
4. The device junction temperature is less than the thermal shutdown temperature ($T_J < T_{SD}$).

11.4.2 Dropout Mode

If the input voltage is below the rated output voltage plus a specified dropout voltage, the device operates in the dropout state and the output voltage tracks the input voltage.

11.4.3 Disabled

The WR0516 can be turned off by forcing the enable pin low, typically with an enable voltage below 0.4V, at which point the pass device is turned off, internal circuits are shutdown, and the output voltage is actively discharged to ground through an internal resistor from output to ground.

12. Application Guide

Note: The information in the Applications section below is not part of WAY-ON's product specifications and WAY-ON does not guarantee its accuracy or completeness. The customer is responsible for determining the suitability of the component for its intended use and should verify and test its design implementation to confirm system functionality.

12.1 Application Information

The WR0516 is a linear voltage regulator with an input voltage of 1.6V to 5.5 V and an output voltage of 0.7 V to 3.6 V. The accuracy is 1.2% for output voltages up to 1.8V and 0.8% for output voltages greater than 1.8 V. The maximum output current is 500 mA. The efficiency of a linear voltage regulator is determined by the ratio of the output voltage to the input voltage, so in order to achieve high efficiency, the differential voltage (V_{IN} - V_{OUT}) must be as small as possible. This section discusses how best to use this device in practical applications.

12.1.1 Capacitor Recommendation

The WR0516 uses ceramic capacitors with low equivalent series resistance (ESR) at the V_{IN} and V_{OUT} pins to increase its stability. Multilayer ceramic capacitors are recommended. These capacitors also have limitations, and ceramic capacitors with X7R-, X5R-, and COG-rated dielectric materials have relatively good capacitance stability at different temperatures. WR0516 is designed to use ceramic capacitors of 1μF or larger at the input and output. Place C_{IN} and C_{OUT} as close to the IN and OUT pins as possible to minimize trace inductance from the capacitor to the device.

12.1.2 Power Dissipation (P_D)

The reliability of the circuit requires reasonable consideration of the power dissipation of the device, the location of the circuit on the PCB, and the proper sizing of the thermal plane. The regulator should be surrounded by no other heat generating devices as much as possible. The power dissipation of the regulator depends on the input and output voltage difference and the load conditions.

P_D can be calculated using the following equation:

$$P_D = (V_{IN} - V_{OUT}) \times I_{OUT}$$

Using the proper input voltage minimizes the power dissipation, resulting in greater efficiency. To obtain the lowest power dissipation, use the minimum input voltage required for normal output voltage.

The maximum power dissipation determines the maximum allowable ambient temperature (T_A) of the device. Power dissipation and junction temperature are typically related to the junction-ambient thermal resistance ($R_{\theta JA}$) and ambient air temperature (T_A) of the PCB and package and are calculated as follows

$$T_J = T_A + (R_{\theta JA} \times P_D)$$

The thermal resistance ($R_{\theta JA}$) depends primarily on the thermal dispersion capability of the PCB design. The total copper area, copper weight, and the location of the plane all affect the thermal dispersion capability, and the PCB and copper laydown area can only be used as a relative measure of the package's thermal performance.

13. Evaluation Modules

Evaluation Modules (EVMs) are available to help evaluate initial circuit performance. We have evaluation modules for different packages, you can contact us to get the evaluation modules or schematics, PCB layout and BOM.

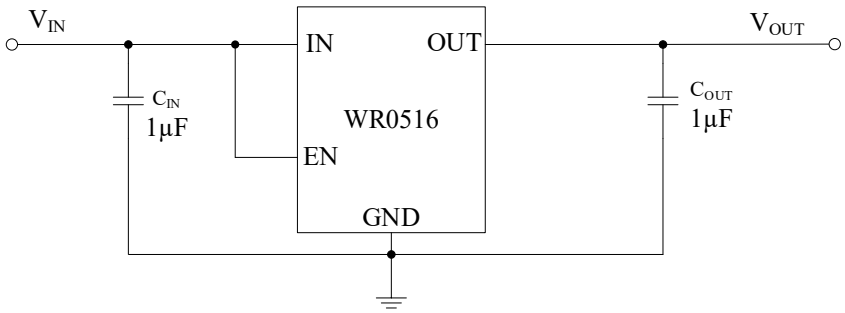
The module names are listed in the following table.

NAME	PACKAGE	EVALUATION MODULE
WR0516	SOT23-5	WAYON LDO EVM V1.1-SOT23-5
	DFN1×1-4	WAYON LDO EVM V1.1-DFN1×1-4

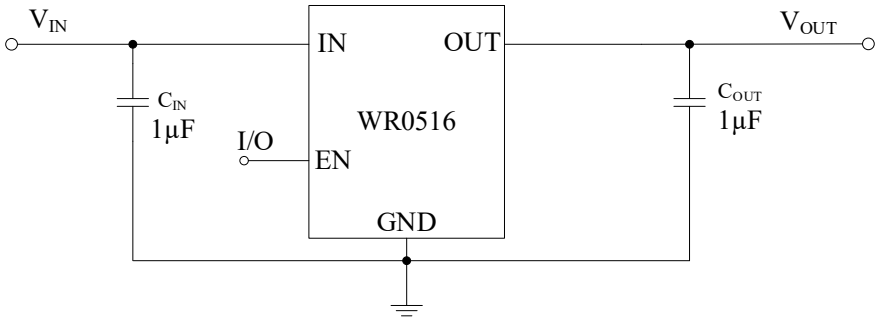
13.1 Schematic

This section discusses the application of the WR0516 in the circuit. The following figure shows the schematic of the application circuit.

Circuit schematic 1: EN is connected to IN.



Circuit schematic 2: EN is controlled by external voltage.

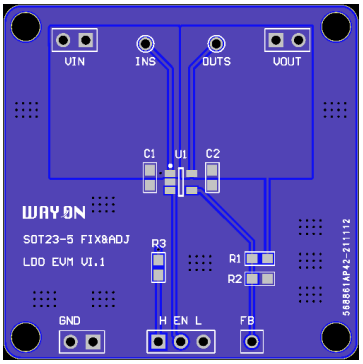


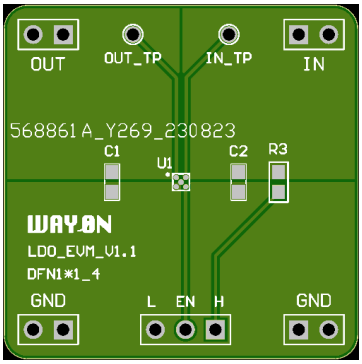
13.2 Layout

Layout Guidelines

The principle of LDO design is to place all components on the same side of the board and connect them as close as possible to their respective LDO pins. A 1.0μF input capacitor (C_{IN}) is recommended to IN to minimize the effect of resistance and inductance between the source and the LDO input. A 1.0μF or larger output capacitor (C_{OUT}) is recommended to OUT. Connect the ground sides of C_{IN} and C_{OUT} with LDO ground pins as close as possible through a wide copper surface. Through-holes and long wires may seriously affect system performance and is not recommended.

To improve thermal performance, an array of thermal vias is used to connect the thermal pad to the ground plane. A larger ground plane improves the thermal performance of the device and reduces the operating temperature of the device.





14. Naming Conventions

WR AA BB-CC DDD E

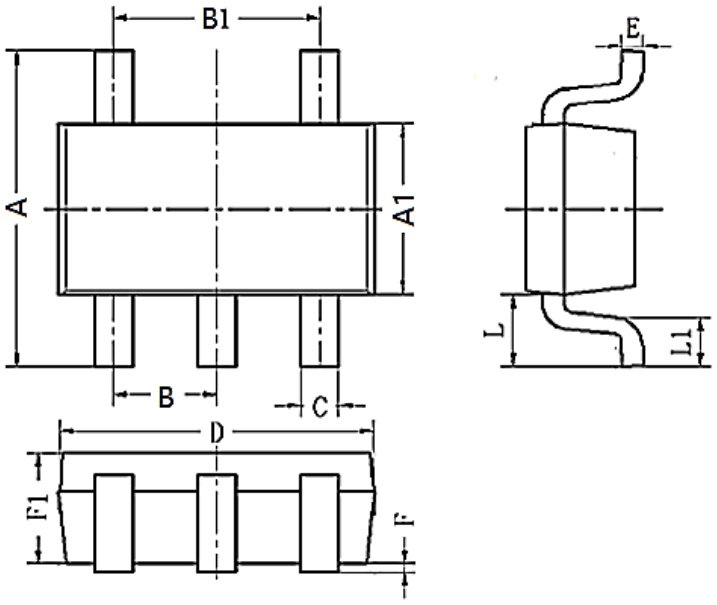
WR: WAYON Regulator;
AA: 05 –Output Current, 500mA;
BB: Serial number;
CC: Output Voltage;
DDD: Package – A50: SOT23-5
FF4: DFN-4
E: R-Reel & T-tube;

15. Electrostatic Discharge Warning

ESD can cause irreversible damage to integrated circuits, ranging from minor performance degradation to device failure. Precision ICs are more susceptible to damage because very minor parameter changes can cause the device to be out of compliance with its published specifications. WAY-ON recommends that all ICs be handled with proper precautions. Failure to follow proper handling practices and installation procedures may damage the IC.

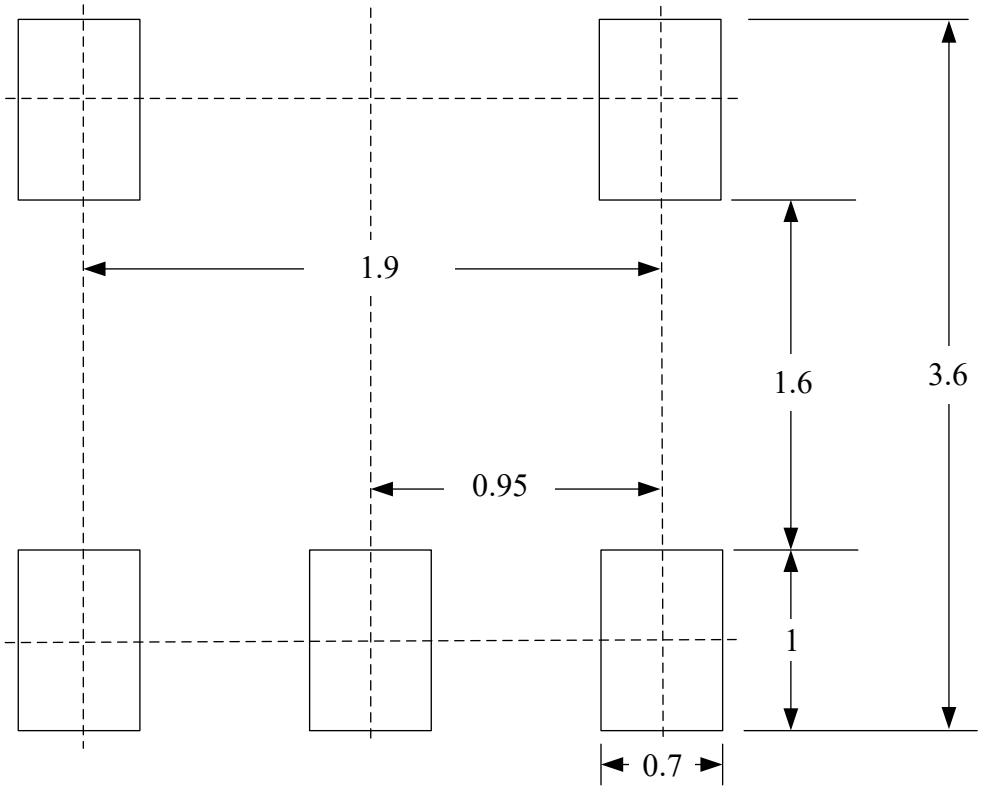
16. Package Information

SOT 23-5



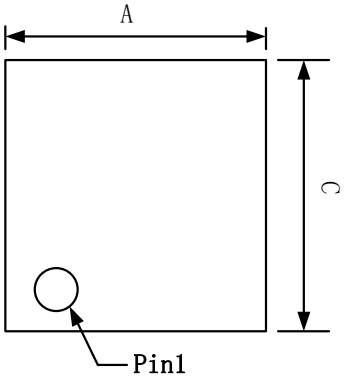
SYMBOL	DIMENSIONS IN MILLIMETERS		
	MIN	NOM	MAX
A	2.60	2.80	3.00
A1	1.50	1.60	1.70
B	0.85	0.95	1.05
B1	1.80	1.90	2.00
C	0.25	0.37	0.50
D	2.79	2.90	3.02
E	0.10	0.15	0.20
F	0.00	0.10	0.20
L	0.60REF		
L1	0.30	0.45	0.60
F1	0.85	1.10	1.30

Suggested Pad Layout: SOT 23-5

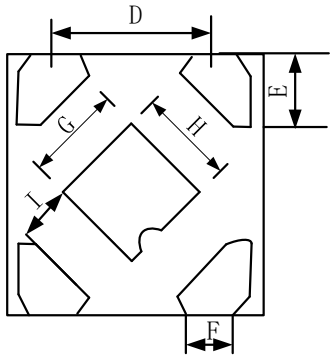


NOTE: Dimensions in Millimeters

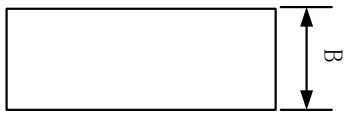
DFN1×1-4



Top View



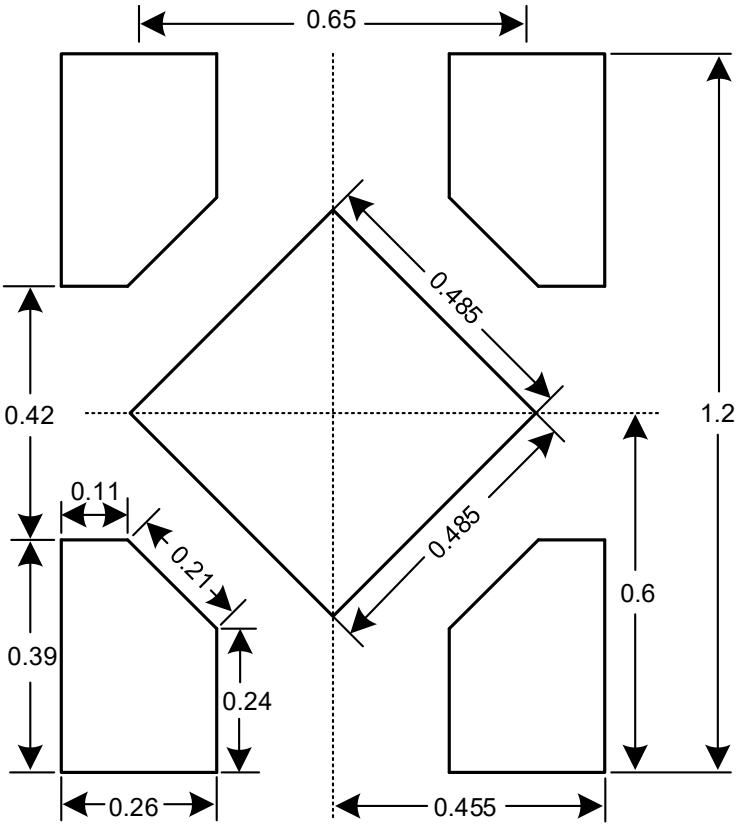
Bottom View



Side View

SYMBOL	DIMENSIONS IN MILLIMETERS		
	MIN	NOM	MAX
A	0.950	1.000	1.050
B	0.320	0.370	0.420
C	0.950	1.000	1.050
D		0.650BSC	
E	0.170	0.270	0.370
F	0.130	0.235	0.300
G	0.430	0.485	0.540
H	0.430	0.485	0.540
I		0.200REF	

Suggested Pad Layout: DFN1×1-4



NOTE: Dimensions in Millimeters

17. Ordering Information

PART NUMBER	OUTPUT VOLTAGE	PACKAGE	PACKING QUANTITY	MARKING*
WR0516-07FF4R	0.7V	DFN1×1-4	10k/Reel	516 07
WR0516-08FF4R	0.8V	DFN1×1-4	10k/Reel	516 08
WR0516-09FF4R	0.9V	DFN1×1-4	10k/Reel	516 09
WR0516-10FF4R	1.0V	DFN1×1-4	10k/Reel	516 10
WR0516-105FF4R	1.05V	DFN1×1-4	10k/Reel	516 105
WR0516-11FF4R	1.1V	DFN1×1-4	10k/Reel	516 11
WR0516-12FF4R	1.2V	DFN1×1-4	10k/Reel	516 12
WR0516-15FF4R	1.5V	DFN1×1-4	10k/Reel	516 15
WR0516-18FF4R	1.8V	DFN1×1-4	10k/Reel	516 18
WR0516-28FF4R	2.8V	DFN1×1-4	10k/Reel	516 28
WR0516-30FF4R	3.0V	DFN1×1-4	10k/Reel	516 30
WR0516-31FF4R	3.1V	DFN1×1-4	10k/Reel	516 31
WR0516-33FF4R	3.3V	DFN1×1-4	10k/Reel	516 33
WR0516-07A50R	0.7V	SOT23-5	3k/Reel	WR0516 07 XXXX
WR0516-08A50R	0.8V	SOT23-5	3k/Reel	WR0516 08 XXXX
WR0516-09A50R	0.9V	SOT23-5	3k/Reel	WR0516 09 XXXX
WR0516-10A50R	1.0V	SOT23-5	3k/Reel	WR0516 10 XXXX
WR0516-105A50R	1.05V	SOT23-5	3k/Reel	WR0516 105 XXXX
WR0516-11A50R	1.1V	SOT23-5	3k/Reel	WR0516 11 XXXX
WR0516-12A50R	1.2V	SOT23-5	3k/Reel	WR0516 12 XXXX
WR0516-15A50R	1.5V	SOT23-5	3k/Reel	WR0516 15 XXXX
WR0516-18A50R	1.8V	SOT23-5	3k/Reel	WR0516 18 XXXX

PART NUMBER	OUTPUT VOLTAGE	PACKAGE	PACKING QUANTITY	MARKING*
WR0516-28A50R	2.8V	SOT23-5	3k/Reel	WR0516 28 XXXX
WR0516-30A50R	3.0V	SOT23-5	3k/Reel	WR0516 30 XXXX
WR0516-31A50R	3.1V	SOT23-5	3k/Reel	WR0516 31 XXXX
WR0516-33A50R	3.3V	SOT23-5	3k/Reel	WR0516 33 XXXX

* XXXX is variable.

Contact Information

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Product Specification Statement

1.The product specification aims to provide users with a reference regarding various product parameters, performance, and usage. It presents certain aspects of the product's performance in graphical form and is intended solely for users to select product and make product comparisons, enabling users to better understand and evaluate the characteristics and advantages of the product. It does not constitute any commitment, warranty, or guarantee.

2.The product parameters described in the product specification are numerical values, characteristics, and functions obtained through actual testing or theoretical calculations of the product in an independent or ideal state. Due to the complexity of product applications and variations in test conditions and equipment, there may be slight fluctuations in parameter test values. WAYON shall not guarantee that the actual performance of the product when installed in the customer's system or equipment will be entirely consistent with the product specification, especially concerning dynamic parameters. It is recommended that users consult with professionals for product selection and system design. Users should also thoroughly validate and assess whether the actual parameters and performance when installed in their respective systems or equipment meet their requirements or expectations. Additionally, users should exercise caution in verifying product compatibility issues, and WAYON assumes no responsibility for the application of the product.

3.WAYON strives to provide accurate and up-to-date information to the best of our ability. However, due to technical, human, or other reasons, WAYON cannot guarantee that the information provided in the product specification is entirely accurate and error-free. WAYON shall not be held responsible for any losses or damages resulting from the use or reliance on any information in these product specifications. WAYON reserves the right to revise or update the product specification and the products at any time without prior notice, and the user's continued use of the product specification is considered an acceptance of these revisions and updates. Prior to purchasing and using the product, users should verify the above information with WAYON to ensure that the product specification is the most current, effective, and complete. If users are particularly concerned about product parameters, please consult WAYON in detail or request relevant product test reports. Any data not explicitly mentioned in the product specification shall be subject to separate agreement.

4.Users are advised to pay attention to the parameter limit values specified in the product specification and maintain a certain margin in design or application to ensure that the product does not exceed the parameter limit values defined in the product specification. This precaution should be taken to avoid exceeding one or more of the limit values, which may result in permanent irreversible damage to the product, ultimately affecting the quality and reliability of the system or equipment.

5.The design of the product is intended to meet civilian needs and is not guaranteed for use in harsh environments or precision equipment. It is not recommended for use in systems or equipment such as medical devices, aircraft, nuclear power, and similar systems, where failures in these systems or equipment could reasonably be expected to result in personal injury. WAYON shall assume no responsibility for any consequences resulting from such usage.

6.Users should also comply with relevant laws, regulations, policies, and standards when using the product specification. Users are responsible for the risks and liabilities arising from the use of the product specification and must ensure that it is not used for illegal purposes. Additionally, users should respect the intellectual property rights related to the product specification and refrain from infringing upon any third-party legal rights. WAYON shall assume no responsibility for any disputes or controversies arising from the above-mentioned issues in any form.